# 2SC458, 2SC2308

Silicon NPN Epitaxial

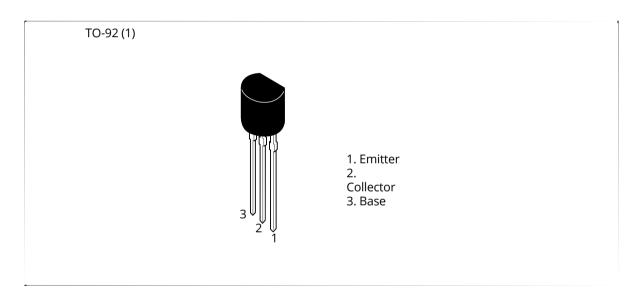
# HITACHI

ADE-208-1043 (Z) 1st. Edition Mar. 2001

# Application

- Low frequency amplifier
- Complementary pair with 2SA1029 and 2SA1030

## Outline





# **Absolute Maximum Ratings** (Ta = 25°C)

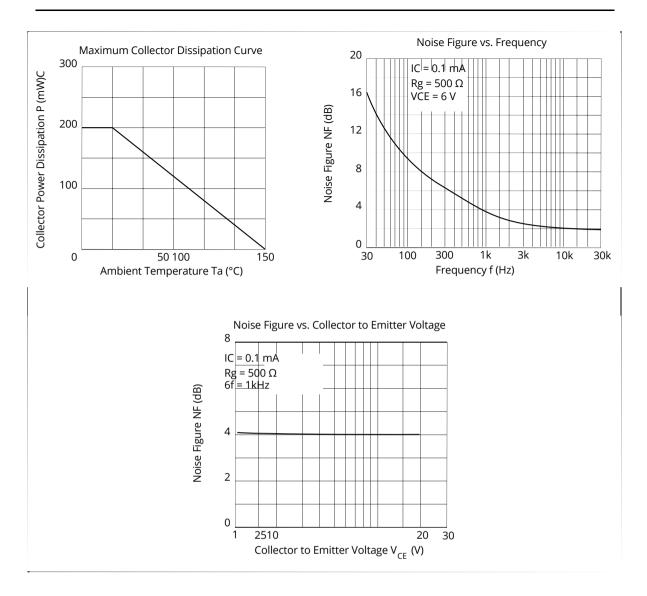
Item	Symbol	<b>2SC</b> 458	2SC2308	Unit
Collector to base voltage	VCBO	30	55	V
Collector to emitter voltage	VCEO	30	50	V
Emitter to base voltage	VEBO	5	5	V
Collector current	IC	100	100	mA
Emitter current	IE	-100	-100	mA
Collector power dissipation	PC	200	200	mW
Junction temperature	Tj	150	150	e
Storage temperature	Tstg	–55 to +150	–55 to +150	e

# **Electrical Characteristics** (Ta = 25°C)

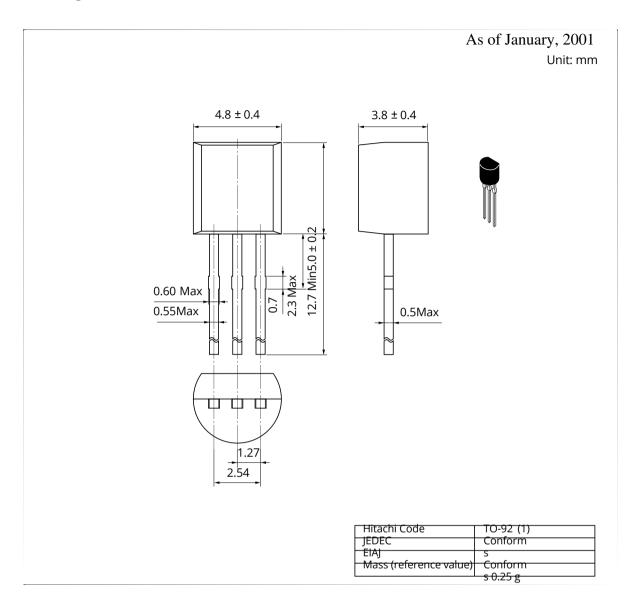
#### 2SC458 2SC2308

Item Symbol Min Typ Max Min Typ	Max Unit	Test conditions
Collector to baseV(BR)CBO30——55— breakdown voltage	— V	IC = 10 µA, IE = 0
Collector to emitterV(BR)CEO30——50—	— V	IC = 1 mA, RBE = ∞
breakdown voltage Emitter to baseV(BR)EBO5——5—	<u> </u>	IE = 10 μΑ, IC = 0
breakdown voltage	0.5 µA	VCB =18 V, IE = 0
Collector cutoff currentlCBO——0.5——	0.5 µA	VEB = 2 V, IC = 0
Emitter cutoff currentIEBO——0.5——	320	VCE = 12 V, IC = 0
DC current transfer ratioh1FE*100—500100—	0.2V	VCL = 12 v, IC = 2 IIIA IC = 10 mA, IB = 1 mA
Collector to emitterVCE(sat)——0.2—— saturation voltage	0.75 V	VCE = 12 V, IC = 2 mA
Base to emitter voltageVBE—0.670.75—0.67	—MHz	VCE = 12 V, IC = 2 mA
Gain bandwidth productfT—230—230	3.5 pF	VCB = 10 V, IE = 0.
-Collector outputCob 1.83.5 1.8 capacitance	10dB	f = 1 MHz
_Noise figureNF—410—4	—kΩ	VCE = 6 V, IC = 0.1 mA, f = 1 kHz, Rg = 500 Ω
-Small signal inputhie—16.5——16.5 impedance	—× 10-6	VCE = 5V, IC = 0.1mA, f = 270 Hz
-Small signal voltagehre—70——70	_	_
feedback ratio - <del>Small signal currenthfe—130——130</del>	—µS	
trancefer ratio	·	
-Small signal outputhoe—11.0——11.0		_
admittance		
Note:1.The 2SC458 and 2SC2308 are grouped by hFE as follows.		
BCD		
_2SC458100 to 200160 to 320250 to 500		
_2SC2308100 to 200160 to 320—		

See characteristic curves of 2SC458 (LG) and 2SC2310 except for the followings.



## **Package Dimensions**



#### 2SC458, 2SC2308

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